

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

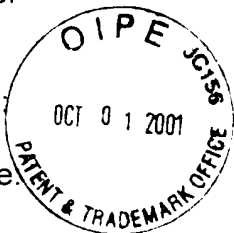
Applicants: Loi Nguyen
Ravishankar Sundaresan

Serial No.: 09/488,686

Filing Date: January 20, 2000

Title: SRAM CELL FABRICATION WITH INTERLEVEL
DIELECTRIC PLANARIZATION

Attorney Docket No.: 93-C-078RE (1678-20)



CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited in the United States Postal Service as First Class Mail in an envelope addressed to Assistant Commissioner for Patents, Washington, D.C. 20231 on this 26th day of September, 2001.

Signature

RESPONSE TO OFFICE ACTION

September 26, 2001

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

In response to the most recent Office Action in this case mailed July 26, 2001, the Applicants, acting through their attorney, submit the original Letters Patent No. 5,710,461.

In the event additional fees are due as a result of this response, payment for those fees has been enclosed in the form of a check. Should further payment be

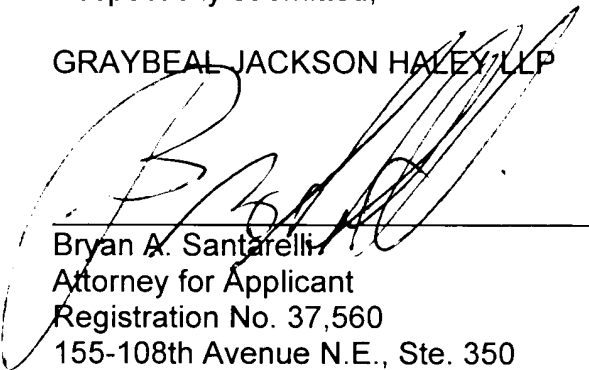
required to cover such fees you are hereby authorized to charge such payment to
Deposit Account No. 07-1897.

If the Examiner believes that a phone interview would be helpful, he is
respectfully requested to contact the Applicants' attorney, Bryan Santarelli, at
(425) 455-5575.

DATED this 26th day of September, 2001.

Respectfully submitted,

GRAYBEAL JACKSON HALEY LLP



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